

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

*In re* Application of: Virgil Cotoco Ararao, et al. : Confirmation No.: 6546  
Serial No.: 10/721,916 : Art Unit: 2813  
Filed: 11/24/2003 : Examiner: Thanh T. Nguyen  
For: FABRICATION METHOD :  
FOR SEMICONDUCTOR  
PACKAGE HEAT  
SPREADERS

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT AFTER FINAL REJECTION  
UNDER 37 C.F.R. §1.116  
AND SUMMARY OF EXAMINER TELEPHONIC INTERVIEW**

Madam:

The following Amendment and Remarks are submitted under 37 C.F.R. §1.116 in response to the Final Office Action mailed February 21, 2006, following the amendment format set forth under 37 CFR §1.121. After this introductory section, there are Amendments to the Claims, and then Remarks that includes a Summary of Examiner Telephonic Interview, each starting on a separate page.

Amendments to the Claims consist of amendments for claims 1, 9, 21, and 29, which are incorporated in a complete listing of the claims.

Reconsideration of the rejections is respectfully requested.